



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Hiroyuki KUMAKURA

Application No.: 09/761,191

Filed: January 18, 2001

For: ADHESIVE COMPOSITION

Group Art Unit: 1711

Examiner: S. McClendon

Docket No.: 108379

#5/B
5/14/02

AMENDMENT

Director of the U.S. Patent and Trademark Office
Washington, D.C. 20231

Sir:

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MAY 13 2002
TC 1700

In reply to the Office Action mailed February 13, 2002, please amend the
above-identified application as follows:

IN THE CLAIMS:

Please replace claims 1, 3 and 5 as follows:

Subcl
B1

1. (Amended) An adhesive composition, comprising:
an insulating resin;
a photopolymerization initiator; and
an oxetan compound having two oxetane functional groups.

B2

3. (Twice Amended) The adhesive composition according to claim 1, further
comprising electrically conductive particles.

B3

5. (Amended) The adhesive composition according to claim 2, further comprising
electrically conductive particles.